



# SGM2045LC

## 300mA, Low $V_{IN}$ , Ultra-Low Noise, Low Start-Up Current, High PSRR Linear Regulator

### GENERAL DESCRIPTION

The SGM2045LC is an ultra-low noise, low  $V_{IN}$ , high PSRR and low dropout voltage linear regulator. It is capable of supplying 300mA output current with typical dropout voltage of only 100mV. The operating input voltage range is from 1.8V to 5.5V and output voltages are 1.2V, 1.8V and 2.8V.

Other features include logic-controlled shutdown mode, short-circuit current limit and thermal shutdown protection. The SGM2045LC has automatic discharge function to quickly discharge  $V_{OUT}$  in the disabled status.

The SGM2045LC is suitable for applications which need low noise and fast transient response power supply, such as power supply of camera module in smart phone, etc.

The SGM2045LC is available in a Green XTDFN-1×1-4L package. It operates over an operating temperature range of -40°C to +125°C.

### FEATURES

- **Operating Input Voltage Range: 1.8V to 5.5V**
- **Fixed Output Voltage Options: 1.2V, 1.8V, 2.8V**
- **300mA Output Current**
- **Output Voltage Accuracy:  $\pm 1\%$  at +25°C**
- **Low Quiescent Current: 15 $\mu$ A (TYP)**
- **Low Dropout Voltage:**
  - **100mV (TYP) at 300mA when  $V_{OUT} = 1.8V$**
- **Ultra-Low Noise: 9.5 $\mu$ V<sub>RMS</sub> (TYP)**
- **High PSRR: 92dB (TYP) at 1kHz**
- **Low Start-Up Current**
- **Current Limiting and Thermal Protection**
- **Excellent Load and Line Transient Responses**
- **With Output Automatic Discharge**
- **Stable with Small Case Size Ceramic Capacitors**
- **Shutdown Supply Current: 0.03 $\mu$ A (TYP)**
- **-40°C to +125°C Operating Temperature Range**
- **Available in a Green XTDFN-1×1-4L Package**

### APPLICATIONS

Portable Electronic Devices  
Smoke Detectors  
IP Cameras  
Wireless LAN Devices  
Battery-Powered Equipment  
Smartphones and Tablets  
Digital Cameras and Audio Devices

### TYPICAL APPLICATION

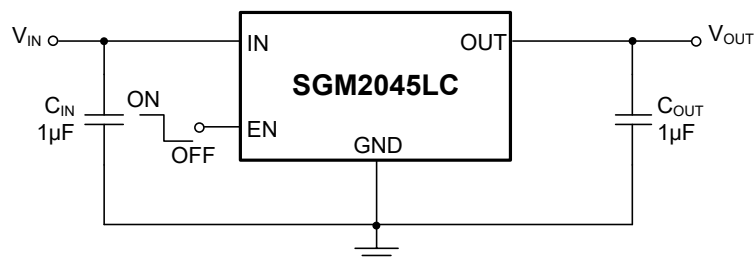


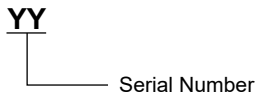
Figure 1. Typical Application Circuit

# 300mA, Low $V_{IN}$ , Ultra-Low Noise, SGM2045LC Low Start-Up Current, High PSRR Linear Regulator

## PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
SGM2045LC-1.2	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.2XXDH4G/TR	4V	Tape and Reel, 10000
SGM2045LC-1.8	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-1.8XXDH4G/TR	2X	Tape and Reel, 10000
SGM2045LC-2.8	XTDFN-1×1-4L	-40°C to +125°C	SGM2045LC-2.8XXDH4G/TR	2Y	Tape and Reel, 10000

## MARKING INFORMATION



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

### ABSOLUTE MAXIMUM RATINGS

IN to GND .....	-0.3V to 6V
EN to GND .....	-0.3V to 6V
OUT to GND .....	-0.3V to ( $V_{IN} + 0.3V$ )
Package Thermal Resistance	
XTDFN-1×1-4L, $\theta_{JA}$ .....	242°C/W
XTDFN-1×1-4L, $\theta_{JB}$ .....	107°C/W
XTDFN-1×1-4L, $\theta_{JC}$ .....	238°C/W
Junction Temperature .....	+150°C
Storage Temperature Range .....	-65°C to +150°C
Lead Temperature (Soldering, 10s) .....	+260°C
ESD Susceptibility	
HBM .....	8000V
CDM .....	1000V

### RECOMMENDED OPERATING CONDITIONS

Input Voltage Range .....	1.8V to 5.5V
Enable Input Voltage Range .....	0V to 5.5V
Input Effective Capacitance, $C_{IN}$ .....	0.1 $\mu$ F (MIN)
Output Effective Capacitance, $C_{OUT}$ .....	0.5 $\mu$ F to 200 $\mu$ F <sup>(1)</sup>
Operating Junction Temperature Range .....	-40°C to +125°C

#### NOTE:

- To maintain a 100 $\mu$ A minimum output current when the output effective capacitance is more than 10 $\mu$ F.

### OVERSTRESS CAUTION

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

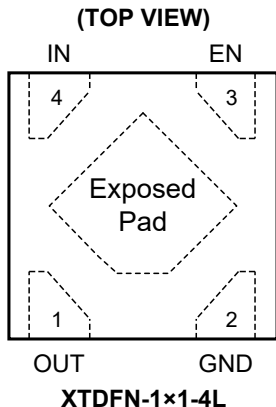
### ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

### DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

## PIN CONFIGURATION



## PIN DESCRIPTION

PIN	NAME	FUNCTION
1	OUT	Regulator Output Pin. It is recommended to use a ceramic capacitor with effective capacitance in the range of 0.5 $\mu$ F to 200 $\mu$ F to ensure stability. This ceramic capacitor should be placed as close as possible to OUT pin.
2	GND	Ground.
3	EN	Enable Pin. Drive EN high to turn on the regulator. Drive EN low to turn off the regulator. The EN pin has an internal 0.03 $\mu$ A pull-down current source which ensures that the device is turned off when the EN pin is floated. This pin must be connected to IN pin if enable functionality is not used.
4	IN	Input Supply Voltage Pin. It is recommended to use a 1 $\mu$ F or larger ceramic capacitor from IN pin to ground to get good power supply decoupling. This ceramic capacitor should be placed as close as possible to IN pin.
Exposed Pad	—	Exposed Pad. Connect it to a large ground plane to maximize thermal performance; this pad is not an electrical connection point.

# SGM2045LC 300mA, Low $V_{IN}$ , Ultra-Low Noise, Low Start-Up Current, High PSRR Linear Regulator

## ELECTRICAL CHARACTERISTICS

( $V_{IN} = V_{OUT(NOM)} + 0.3V$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = C_{OUT} = 1\mu F$ ,  $T_J = -40^\circ C$  to  $+125^\circ C$ , typical values are at  $T_J = +25^\circ C$ , unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
Input Voltage Range	$V_{IN}$		1.8		5.5	V	
Output Voltage Accuracy	$V_{OUT}$	$I_{OUT} = 0.1mA$ , $T_J = +25^\circ C$	-1		1	%	
		$I_{OUT} = 0.1mA$ to $300mA$ , $V_{IN} = (V_{OUT(NOM)} + 0.3V)$ to $5.5V$ , $T_J = -40^\circ C$ to $+125^\circ C$	-2.5		2.5		
Line Regulation	$\Delta V_{LNR}$	$V_{IN} = (V_{OUT(NOM)} + 0.3V)$ to $5.5V$ , $I_{OUT} = 0.1mA$		0.05	2.5	mV	
Load Regulation	$\Delta V_{LDR}/V_{OUT}$	$I_{OUT} = 0.1mA$ to $300mA$		0.4	10	mV/V	
Dropout Voltage <sup>(1)</sup>	$V_{DROP}$	$I_{OUT} = 300mA$	$V_{OUT(NOM)} = 1.8V$		100	190	mV
			$V_{OUT(NOM)} = 2.8V$		70	150	
Output Current Limit	$I_{LIMIT}$	$V_{OUT} = 90\% \times V_{OUT(NOM)}$ , $V_{IN} = V_{OUT(NOM)} + 0.3V$	$T_J = -20^\circ C$ to $+125^\circ C$	300	600		mA
			$T_J = -40^\circ C$ to $+125^\circ C$	260	600		
Short-Circuit Current	$I_{SHORT}$	$V_{OUT} = 0V$		380		mA	
Quiescent Current	$I_Q$	$I_{OUT} = 0mA$		15	40	$\mu A$	
Shutdown Supply Current	$I_{SHDN}$	$V_{EN} = 0V$ , $V_{IN} = 5.5V$		0.03	2	$\mu A$	
EN Input Threshold Voltage	$V_{IH}$	$V_{IN} = 1.8V$ to $5.5V$	0.7			V	
	$V_{IL}$				0.3		
EN Pull-Down Current	$I_{EN}$	$V_{EN} = 5.5V$ , $V_{IN} = 5.5V$		0.03	1	$\mu A$	
Output Discharge Resistance	$R_{DIS}$	$V_{EN} = 0V$ , $V_{OUT} = 0.2V$ , $V_{IN} = 3.3V$		60		$\Omega$	
Turn-On Time	$t_{ON}$	From EN rising from $0V$ to $V_{IN}$ to $90\% \times V_{OUT(NOM)}$ , no load		380	600	$\mu s$	
Power Supply Rejection Ratio	PSRR	$I_{OUT} = 20mA$ , $V_{OUT(NOM)} = 1.8V$ , $V_{IN} = 2.8V$	$f = 100Hz$		90		dB
			$f = 1kHz$		92		
			$f = 10kHz$		80		
			$f = 100kHz$		53		
Output Voltage Noise	$e_n$	$f = 10Hz$ to $100kHz$ , $I_{OUT} = 20mA$ , $V_{OUT(NOM)} = 1.8V$		9.5		$\mu V_{RMS}$	
Thermal Shutdown Temperature	$T_{SHDN}$			160		$^\circ C$	
Thermal Shutdown Hysteresis	$\Delta T_{SHDN}$			20		$^\circ C$	

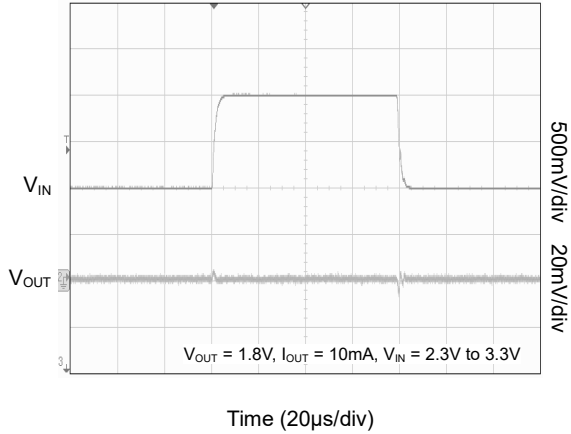
**NOTE:**

1. The dropout voltage is defined as the difference between  $V_{IN}$  and  $V_{OUT}$  when  $V_{OUT}$  falls to  $(V_{OUT(NOM)} - 50mV)$ .

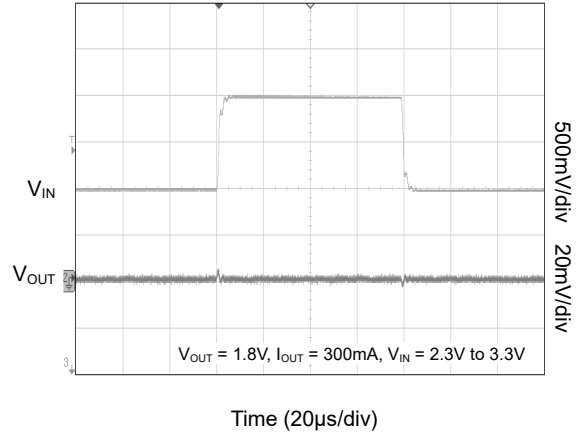
**TYPICAL PERFORMANCE CHARACTERISTICS**

$T_J = +25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.3\text{V}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = C_{OUT} = 1\mu\text{F}$ , unless otherwise noted.

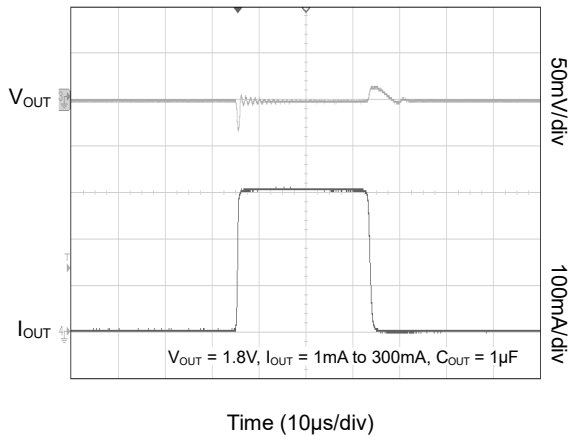
Line Transient Response



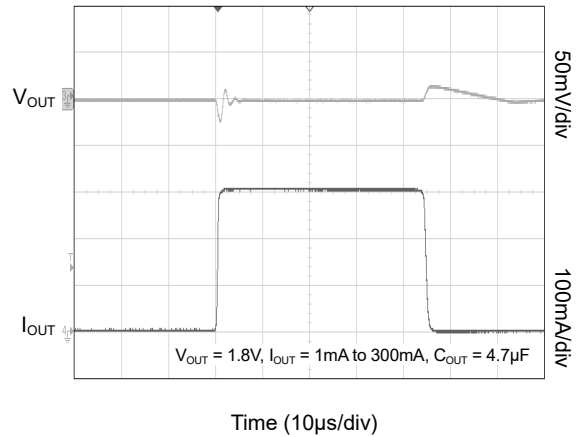
Line Transient Response



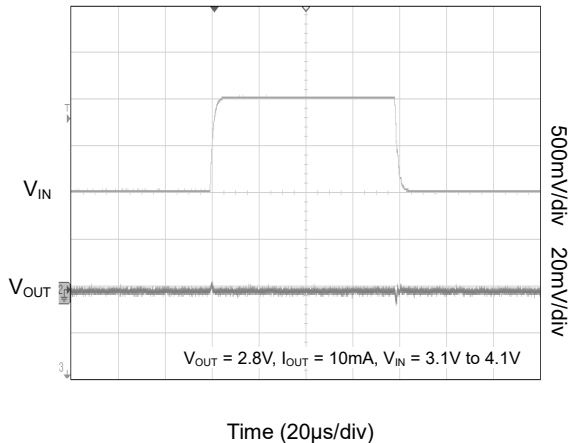
Load Transient Response



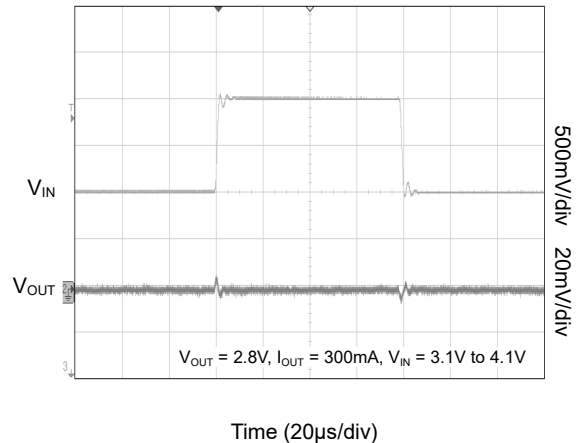
Load Transient Response



Line Transient Response

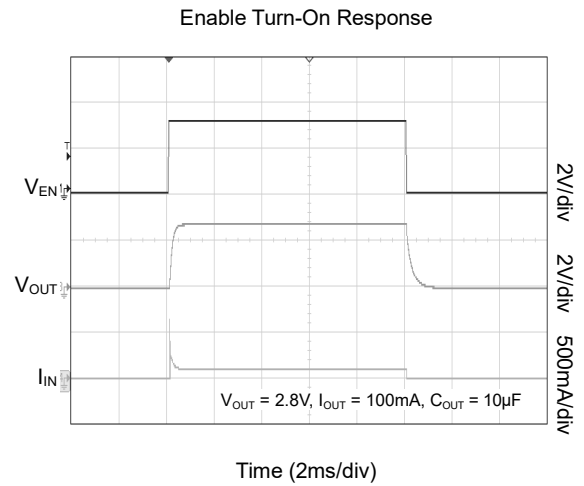
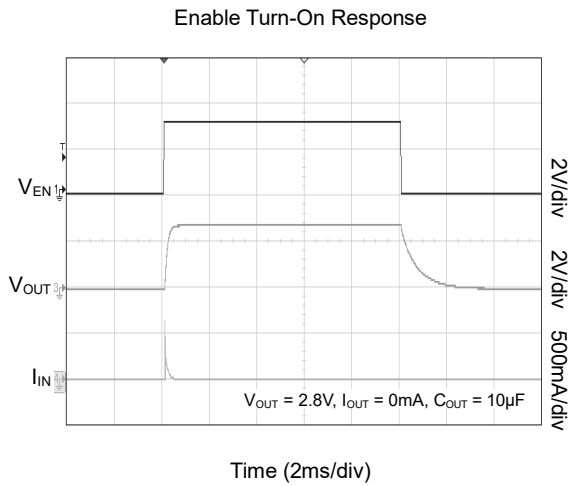
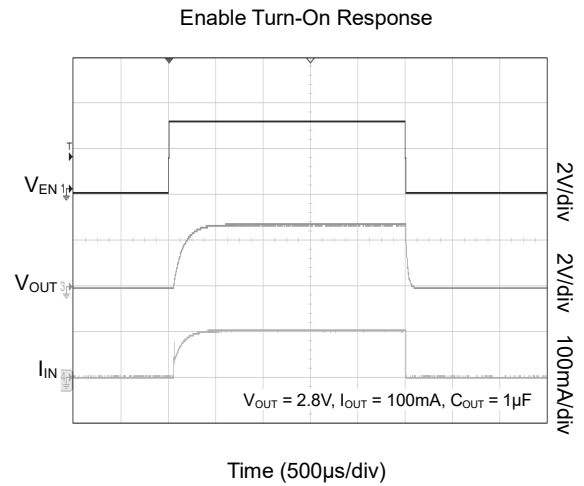
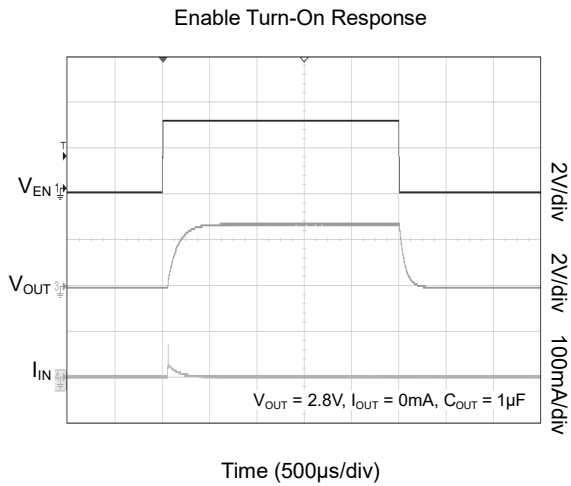
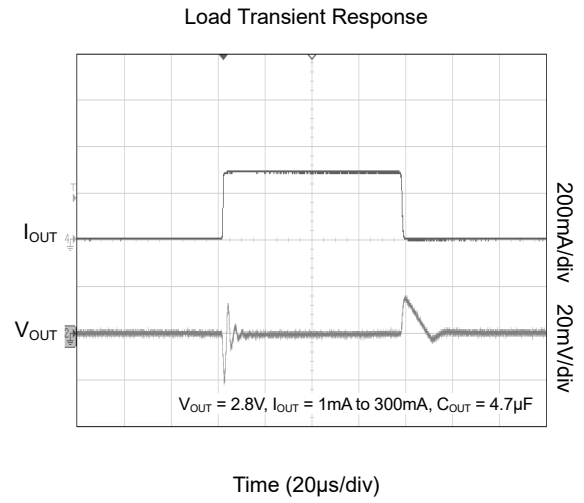
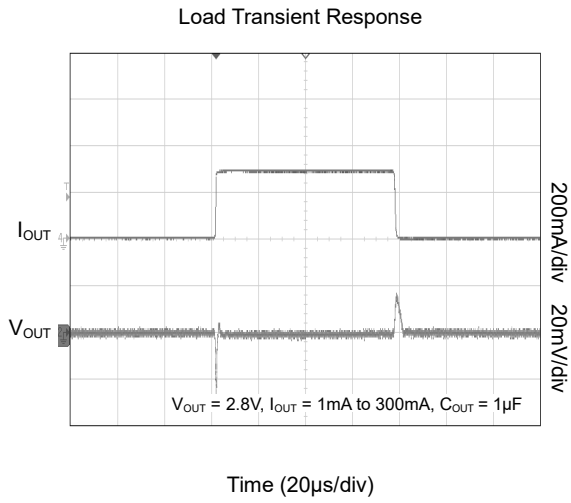


Line Transient Response



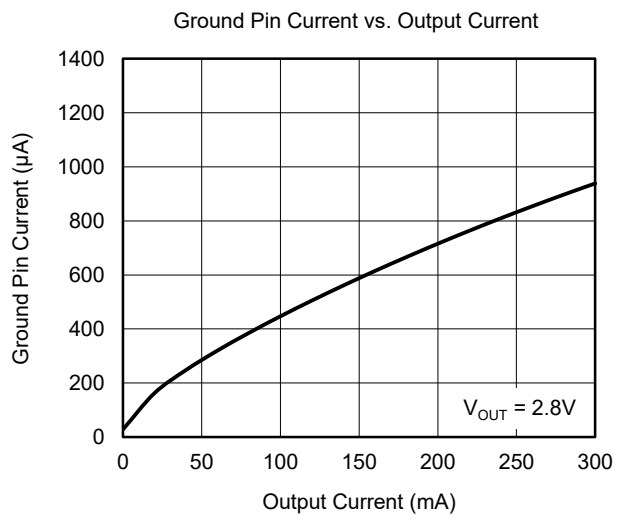
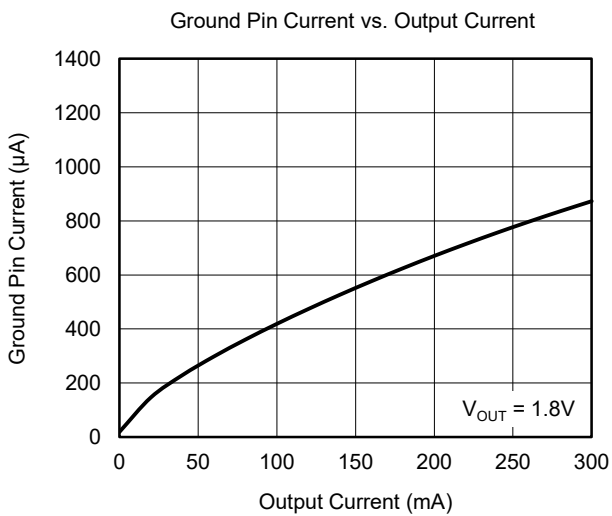
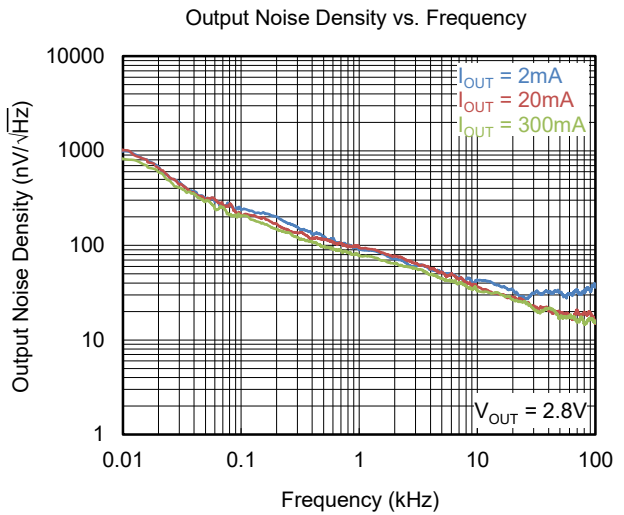
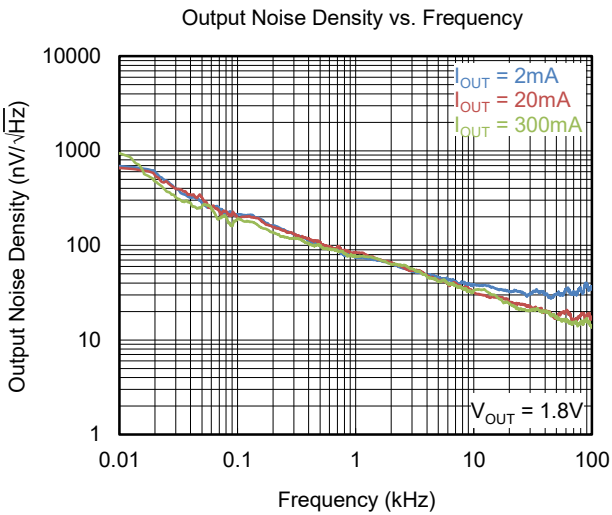
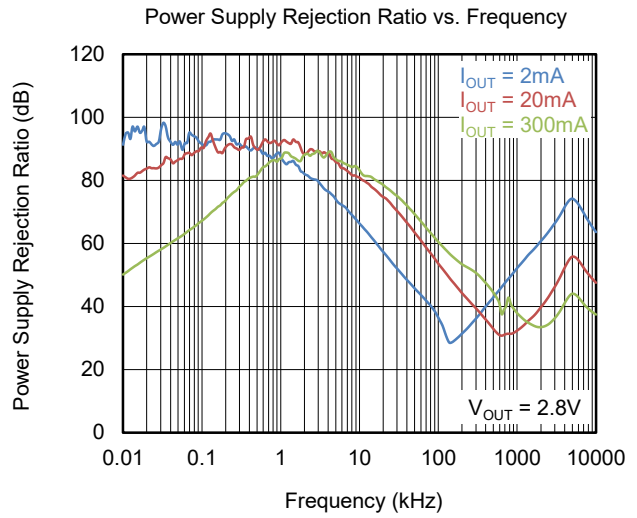
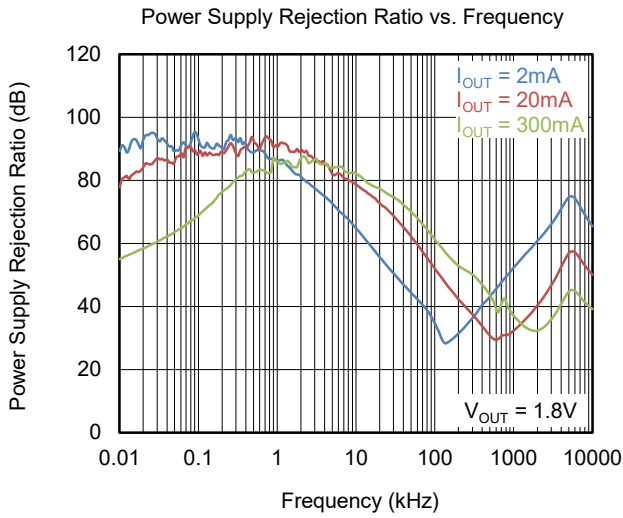
**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

$T_J = +25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.3\text{V}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = C_{OUT} = 1\mu\text{F}$ , unless otherwise noted.



**TYPICAL PERFORMANCE CHARACTERISTICS (continued)**

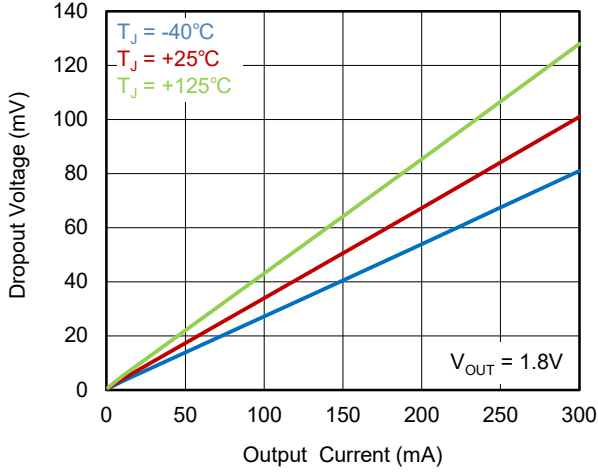
$T_J = +25^\circ\text{C}$ ,  $V_{IN} = V_{OUT(NOM)} + 0.3\text{V}$ ,  $V_{EN} = V_{IN}$ ,  $C_{IN} = C_{OUT} = 1\mu\text{F}$ , unless otherwise noted.



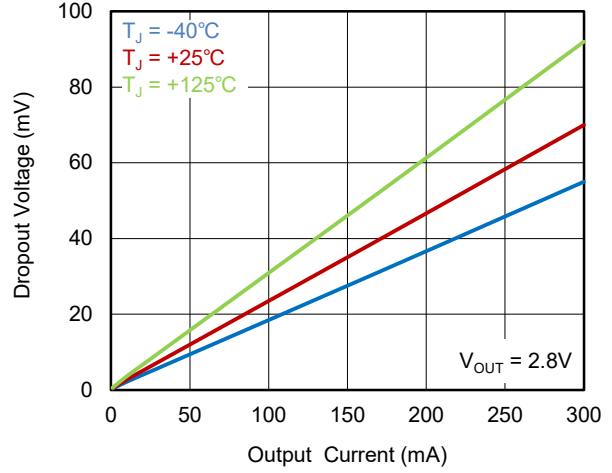
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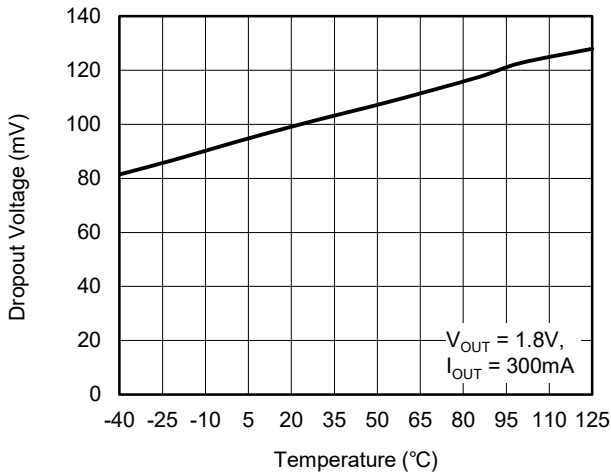
Dropout Voltage vs. Output Current



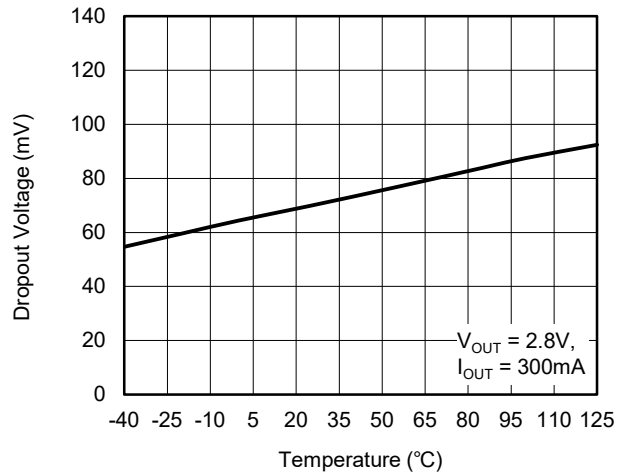
Dropout Voltage vs. Output Current



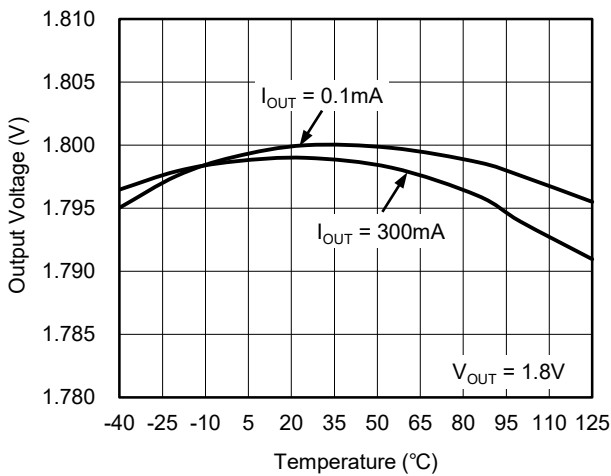
Dropout Voltage vs. Temperature



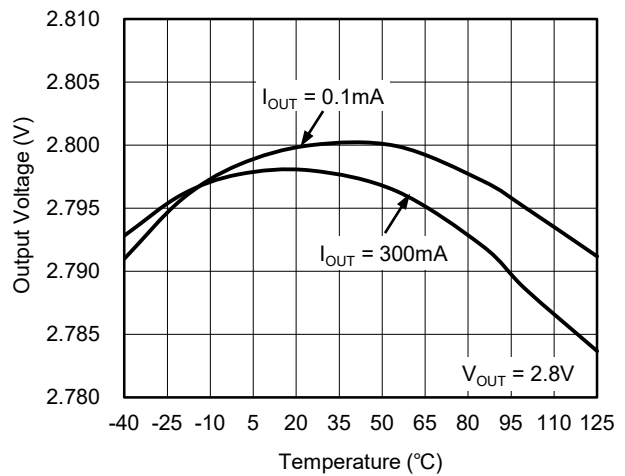
Dropout Voltage vs. Temperature



Output Voltage vs. Temperature



Output Voltage vs. Temperature



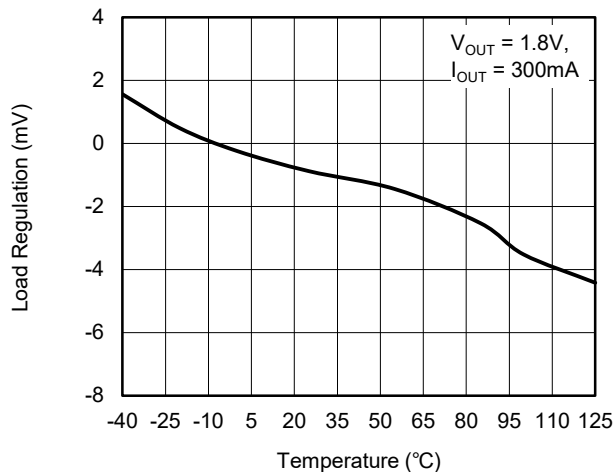


# SGM2045LC 300mA, Low $V_{IN}$ , Ultra-Low Noise, Low Start-Up Current, High PSRR Linear Regulator

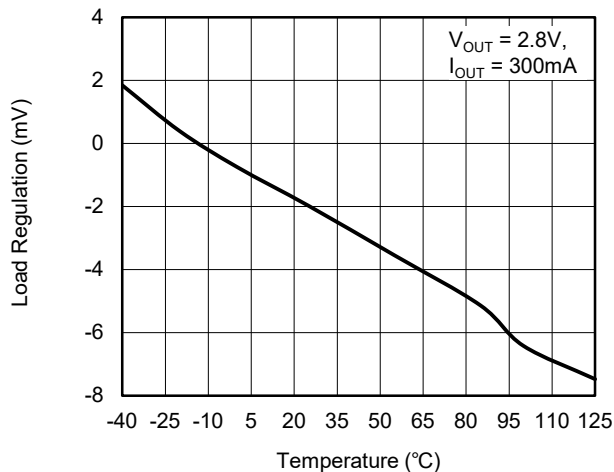
## TYPICAL PERFORMANCE CHARACTERISTICS (continued)

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Load Regulation vs. Temperature



Load Regulation vs. Temperature



# SGM2045LC 300mA, Low $V_{IN}$ , Ultra-Low Noise, Low Start-Up Current, High PSRR Linear Regulator

## FUNCTIONAL BLOCK DIAGRAM

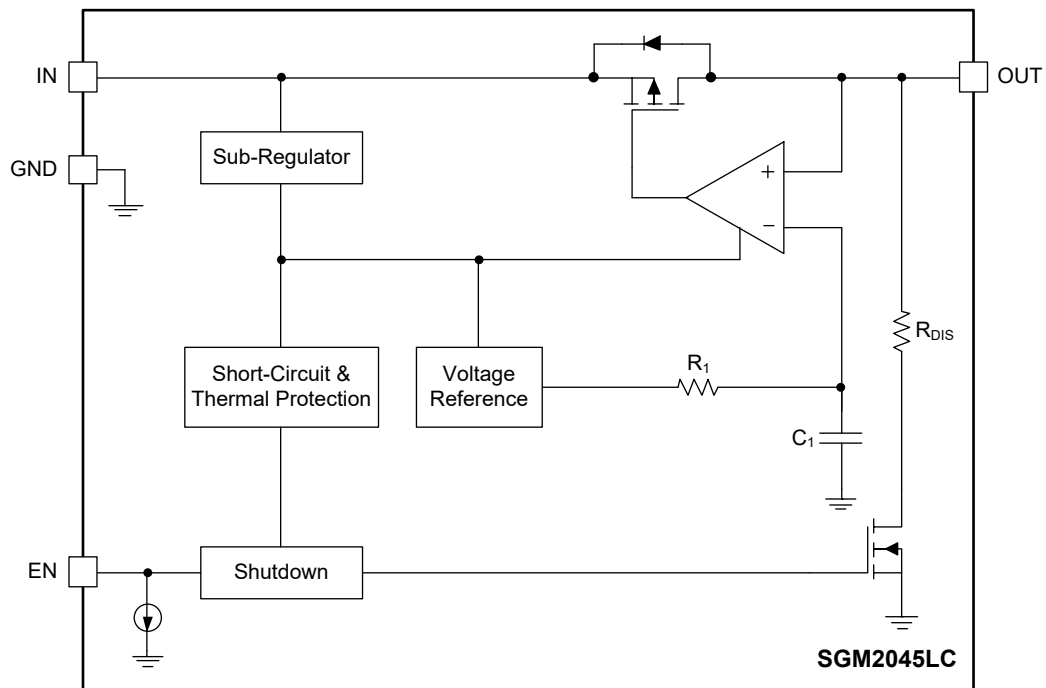


Figure 2. Block Diagram

APPLICATION INFORMATION

The SGM2045LC is a low  $V_{IN}$ , ultra-low noise and low dropout LDO and provides 300mA output current. These features make the device a reliable solution to solve many challenging problems in the generation of clean and accurate power supply. The high performance also makes the SGM2045LC useful in a variety of applications. The SGM2045LC provides the protection functions for output overload, output short-circuit condition and overheating.

The SGM2045LC provides an EN pin as an external chip enable control to enable/disable the device. When the regulator is in shutdown state, the shutdown current consumes as low as 0.03 $\mu$ A (TYP).

Input Capacitor Selection ( $C_{IN}$ )

The input decoupling capacitor should be placed as close as possible to the IN pin for ensuring the device stability. 1 $\mu$ F or larger X7R or X5R ceramic capacitor is selected to get good dynamic performance.

When  $V_{IN}$  is required to provide large current instantaneously, a large effective input capacitor is required. Multiple input capacitors can limit the input tracking inductance. Adding more input capacitors is available to restrict the ringing and to keep it below the device absolute maximum ratings.

Output Capacitor Selection ( $C_{OUT}$ )

The output capacitor should be placed as close as possible to the OUT pin. 1 $\mu$ F or larger X7R or X5R ceramic capacitor is selected to get good dynamic performance. The minimum effective capacitance of  $C_{OUT}$  that SGM2045LC can remain stable is 0.5 $\mu$ F. For ceramic capacitor, temperature, DC bias and package size will change the effective capacitance, so enough margin of  $C_{OUT}$  must be considered in design. Additionally,  $C_{OUT}$  with larger capacitance and lower ESR will help increase the high frequency PSRR and improve the load transient response.

Enable Operation

The EN pin of the SGM2045LC is used to enable/disable its device and to deactivate/activate the output automatic discharge function.

When the EN pin voltage is lower than 0.3V, the device is in shutdown state, there is no current flowing from IN to OUT pins. In this state, the automatic discharge

transistor is active to discharge the output voltage through a 60 $\Omega$  (TYP) resistor.

When the EN pin voltage is higher than 0.7V, the device is in active state, the output voltage is regulated to expected value and the automatic discharge transistor is turned off.

The EN pin is pulled down by internal 0.03 $\mu$ A (TYP) current source when the EN pin is floated. This current source will ensure the SGM2045LC in shutdown state and reduce the power dissipation in system.

Reverse Current Protection

The PMOS power transistor has an inherent body diode. This body diode will be forward biased when  $V_{OUT} > V_{IN}$ . When  $V_{OUT} > V_{IN}$ , the reverse current flowing from the OUT pin to the IN pin will damage the SGM2045LC. If  $V_{OUT} > V_{IN}$  event would happen in system, one external diode will be added between OUT pin and IN pin in circuit design to protect the SGM2045LC.

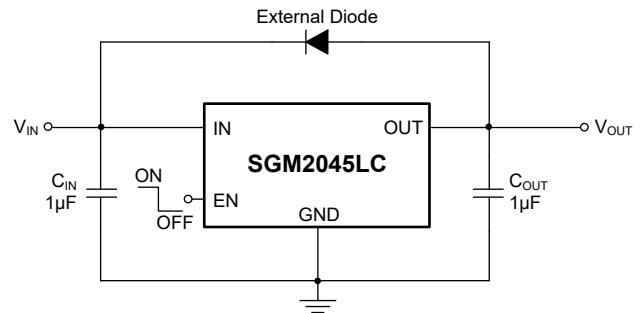


Figure 3. Reverse Protection Reference Design

Negatively Biased Output

When the output voltage is negative, the chip may not start up due to parasitic effects. Ensure that the output is greater than -0.3V under all conditions. If negatively biased output is excessive and expected in the application, a Schottky diode can be added between the OUT pin and GND pin.

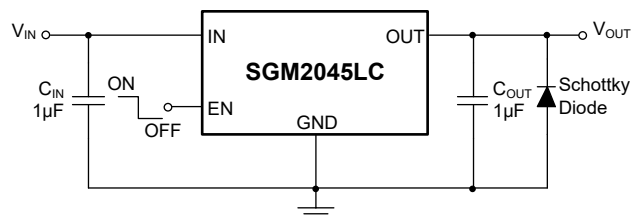


Figure 4. Negatively Biased Output Application

**APPLICATION INFORMATION (continued)**

**Output Current Limit and Short-Circuit Protection**

When overload events happen, the output current is internally limited to 600mA (TYP). When the OUT pin is shorted to ground, the short-circuit protection will limit the output current to 380mA (TYP).

**Thermal Shutdown**

The SGM2045LC can detect the temperature of die. When the die temperature exceeds the threshold value of thermal shutdown, the SGM2045LC will be in shutdown state and it will remain in this state until the die temperature decreases to +140°C.

**Power Dissipation (P<sub>D</sub>)**

Thermal protection limits power dissipation in the SGM2045LC. When power dissipation on pass element (P<sub>D</sub> = (V<sub>IN</sub> - V<sub>OUT</sub>) × I<sub>OUT</sub>) is too much and the operating junction temperature exceeds +160°C, the OTP circuit

starts the thermal shutdown function and turns the pass element off.

Therefore, thermal analysis for the chosen application is important to guarantee reliable performance over all conditions. To guarantee reliable operation, the junction temperature of the SGM2045LC must not exceed +125°C.

The maximum allowable power dissipation depends on the thermal resistance of the IC package, the PCB layout, the rate of surrounding airflow, and the difference between the junction temperature and ambient temperature. The maximum power dissipation can be approximated using the following equation:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA} \quad (1)$$

where T<sub>J(MAX)</sub> is the maximum junction temperature, T<sub>A</sub> is the ambient temperature, and θ<sub>JA</sub> is the junction-to-ambient thermal resistance.

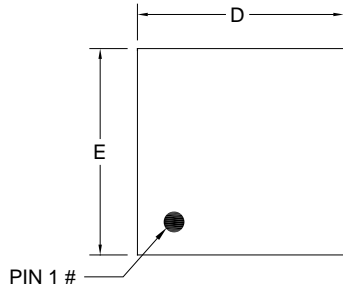
**REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

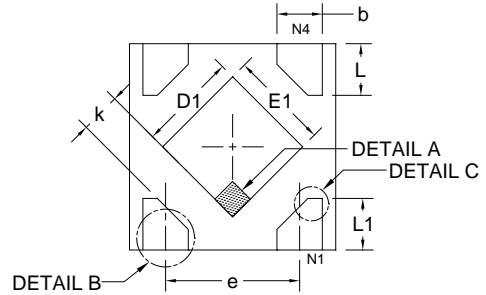
<b>AUGUST 2022 – REV.A.3 to REV.A.4</b>	<b>Page</b>
Updated Recommended Operating Conditions section .....	2
<hr/>	
<b>DECEMBER 2021 – REV.A.2 to REV.A.3</b>	<b>Page</b>
Updated Typical Performance Characteristics section .....	5, 6
<hr/>	
<b>OCTOBER 2021 – REV.A.1 to REV.A.2</b>	<b>Page</b>
Updated Package/Ordering Information section .....	2
<hr/>	
<b>OCTOBER 2021 – REV.A to REV.A.1</b>	<b>Page</b>
Updated Electrical Characteristics section .....	4
<hr/>	
<b>Changes from Original (SEPTEMBER 2021) to REV.A</b>	<b>Page</b>
Changed from product preview to production data .....	All

PACKAGE OUTLINE DIMENSIONS

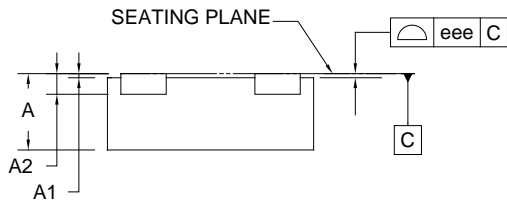
XTDFN-1x1-4L



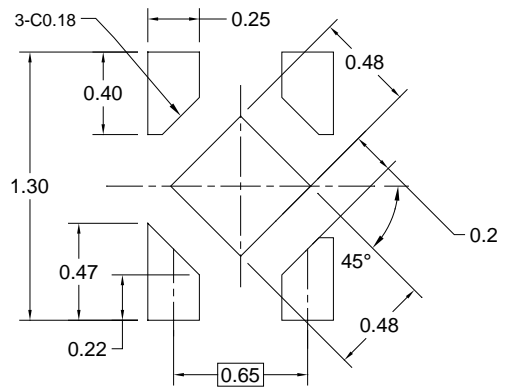
TOP VIEW



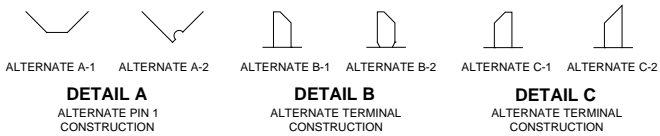
BOTTOM VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN (Unit: mm)



Symbol	Dimensions in Millimeters		
	MIN	MOD	MAX
A	0.340	0.370	0.400
A1	0.000	0.020	0.050
A2	0.100 REF		
b	0.170	-	0.300
D	0.950	1.000	1.050
E	0.950	1.000	1.050
D1	0.430	0.480	0.530
E1	0.430	0.480	0.530
L	0.200	0.250	0.300
L1	0.200	-	0.370
e	0.650 BSC		
k	0.150	-	-
eee	-	0.050	-

NOTE: This drawing is subject to change without notice.

# PACKAGE INFORMATION

## TAPE AND REEL INFORMATION

### REEL DIMENSIONS



### TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

### KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
XTDFN-1×1-4L	7"	9.5	1.16	1.16	0.50	4.0	2.0	2.0	8.0	Q1

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# PACKAGE INFORMATION

## CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

## KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18

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